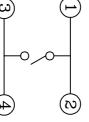
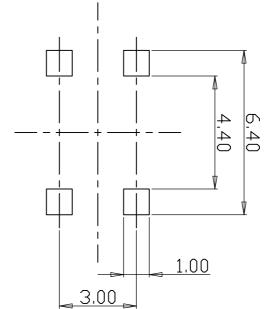
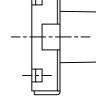


PCB DIMENSION









1. RATING: DC12V, 50mA MAX
2. OPERATING FORCE: 160±50gf
3. TRAVEL: 0.25±0.1mm
4. LIFE CYCLE: 100,000 MIN
5. CONTACT RESISTANCE: 100mΩ MAX

GENERAL TOLERANCE : ± 0.3 mm

N	Δ	A	◬	\triangle	A	
07. 09 .06						No.
NO 07. 09 .06 CORRECTION						DESCR1PTIONS
						SN
APPD				OMETRY	TRIGON-	
CHYD				UNIT SCALE		MATERIAL
APPD CHKD DSGD					AL	
	MODEL INT			OIVID OVVI CI	CMD C	FINSH/COLOR
INT-1127S27A						Q/TY
						REMARK

INNOCENT ELECTRONICS CO., LTD.

1. GENERAL MATTERS

- 1. 1 Application: This specification is applied to low current tactile switch for electronic equipment.
- 1. 2 Operating Temperature Range : $-20\,^{\circ}\text{C} \sim 70\,^{\circ}\text{C}$, 45 $\sim 85\%$ RH
- 1. 3 Test Condition : The standard test conditions shall be 5° C $\sim 35^{\circ}$ C in temperature,

 $45 \sim 85\%$ RH and $860 \sim 1060 mbar$ in atmospheric pressure. Should any doubt arise in judgment, tests shall be conducted

at 20 $\pm 2^{\circ}$ C, 65 $\pm 5\%$ RH and 860 ~ 1060mbar.

2. RATED VOLTAGE AND CURRENT

6V DC, 0.3mA

3. ELECTRICAL PERFORMANCE

	PROPERTY	TEST CONDITION	PERFORMANCE
3. 1	Contact Resistance	Measured at 0.3mA, 6V DC	100mΩ Max
3. 2	Insulation Resistance	DC 500C is applied between terminals and earth for 1 minute ± 5 seconds.	100mΩ Min
3. 3	Withstand Voltage	250V AC(50~ 60HZ) is applied between terminals and earth for 1 minute.	No insulation defect shall be observed.
3. 4	Bounce	Measured by lightly striking the center of the button stem at a rate of 3 operation/sec.	10msec. Max

4. MECHANICAL PERFORMANCE

	PROPERTY	TEST CONDITION	PERFORMANCE
4. 1	Operating Force	A gradually increasing load is applied to the center of the button stem.	160gf±50gf
4. 2	Terminal Strength	A static force of 160gf/250gf shall be applied to an arb	Shall be free from terminal looseness, damage and brea- kdown of insulator.
4. 3	Stop Strength	A static force of 3Kgf shall be applied to the direction of operation for 3 seconds.	Shall be free from mechanical and electrical abnormalities.
4. 4	Solder Heat Resistance	Soldering temperature: 245 ~ 255°C Soldering time: 10sec.	Shall be free from mechanical and electrical degradation.
4. 5	Travel		0.25 ± 0.1mm
4. 6	Arrangement of action		Tactile feed-back

DATE	2011,08.02	DESIGNED	CHECKED	APPROVED	PAGE
S/W TYPE	SMD TACT S/W				1 /
MODEL NO.	INT-1127\$15A				' / _
DOCUMENT NO.		/ /	/ /	/ /	/ 3

5. ENDURANCE

	PROPERTY	TEST CONDITION	PERFORMANCE
5. 1	Operating Life	Measurements shall be made following the test	Contact Resistance :
		set forth below:	200mΩ Max
		1) 5V DC, 5mA resistive load.	Bounce:
		2) Rate of operation 2 to 3 operations per second.	20m sec Max
		3) Depression : Twice the actuating force.	Actuating Force :
		4) Cycles of operation: 100,000 cycles	within $\pm 50\%$ of
			the initial value
			Item 3. 3
			Item 4. 5
5. 2	Vibration Resistance	Measurements shall be made following the test	Item 3. 1
		set forth below:	Item 3. 2
		*Range of oscillation: 10 to 55Hz	Item 3. 3
		*Amplitude, pk-to-pk: 1.5mm	
		*Cycle of sweep: 10-55-10Hz in one minute, approx.	
		*Mode of sweep: logarithmical sweep or uniform	
		sweep.	
		*Direction of oscillation:	
		three mutually perpendicular directions,	
		including the direction of stem travel.	
		*Duration of testing:	
		2 hours each, for a total of 6 hours.	
5. 3	Impact Shock Resistance	Measurements shall be made following the test	Item 3. 1
		set forth below:	Item 3. 2
		*Acceleration: 80g	Item 3. 3
		*cycle of test : 3 cycles each in 6 direction, for a	
		total of 18 cycles.	

6. ENVIRONMENTAL

	PROPERTY	TEST CONDITIONS	PERFORMANCE
6. 1	Resistance to	Following the test set forth below the sample shall	Item 3. 1
	Low Temperature	be left in normal temperature and humidity	Item 3. 2
		conditions for one hour before measurements	Item 3. 3
		are made :	
		*temperature : -30 $\pm 2^{\circ}$ C	
		*time : 96 hours	
		*waterdrops shall be removed.	
6. 2	Heat Resistance	Following the test set forth below the sample shall	Item 3. 1
		be left in normal temperature and humidity	Item 3. 2
		conditions for one hour before measurements	Item 3. 3
		are made :	
		*temperature/time: 80 ±2°C/96hr	

DATE	2011,08.02	DESIGNED	CHECKED	APPROVED	PAGE
S/W TYPE	SMD TACT S/W				. /
MODEL NO.	INT-1127\$15A				$\frac{2}{2}$
DOCUMENT NO.		/ /	/ /	/ /	/ 3

6. ENVIRONMENTAL

	PROPERTY	TEST CONDITION	PERFORMANCE
6.3	Moisture Resistance	Following the test set forth below the sample shall	Contact Resistance :
		be left in normal temperature and humidity	100mΩ Max
		conditions for one hour before measurements	Insulation Resistance:
		are made :	10MΩ Min
		*temperature/time : $80 \pm 2^{\circ}$ C/96hr	Item 3. 3, 3. 4
			Item 4. 1, 4. 5
6. 4	Temperature Cycling	Following 5 cycles of the temperature cycling test	Item 3. 1
		set forth below the sample shall be left in normal	Item 4. 1
		temperature and humidity conditions for one hour	Item 4. 5
		during this test, waterdrops shall be removed.	
		1 cycle +60 °C -10 °C	

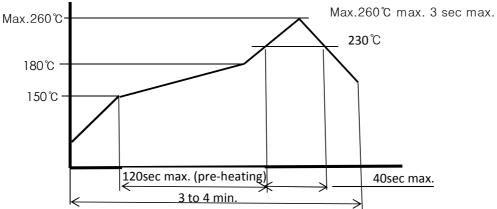
7. REFLOW SOLDERING

7. 1 Refer to the following time temperature chart.

It is recommended to determine soldering conditions through verification test and on prior agreement of INNOCENT ELEC., since surface temperature varies depending upon material, size and thickness PCB.

7. 2 Other precautions

- 1) Switch shall not be washed after soldering with solvent or the like.
- 2) Soldering shall be controlled so as not to allow flux penetrates switch at its upper face.
- 3) Switch terminals and PCB upper face shall be free from flux prior to soldering.



Above-mentions time-temperature chart is based on the temperature in the part mounting surface of PCB.

DATE	2011,08.02	DESIGNED	CHECKED	APPROVED	PAGE
S/W TYPE	SMD TACT S/W				/
MODEL NO.	INT-1127\$15A				3 /
DOCUMENT NO.		/ /	/ /	/ /	/ 3